General Description

The MAX9180 is a 400Mbps, low-voltage differential signaling (LVDS) repeater, which accepts a single LVDS input and duplicates the signal at a single LVDS output. Its low-jitter, low-noise performance makes it ideal for buffering LVDS signals sent over long distances or noisy environments, such as cables and backplanes.

The MAX9180's tiny size makes it especially suitable for minimizing stub lengths in multidrop backplane applications. The SC70 package (half the size of a SOT23) allows the MAX9180 to be placed close to the connector, thereby minimizing stub lengths and reflections on the bus. The point-to-point connection between the MAX9180 output and the destination IC, such as an FPGA or ASIC, allows the destination IC to be located at greater distances from the bus connector.

Ultra-low, 23psp-p added deterministic jitter and 0.6ps_{RMS} added random jitter ensure reliable communication in high-speed links that are highly sensitive to timing errors, especially those incorporating clock-anddata recovery, PLLs, serializers, or deserializers. The MAX9180's switching performance guarantees a 400Mbps data rate, but minimizes radiated noise by guaranteeing 0.5ns minimum output transition time.

The MAX9180 has fail-safe circuitry that sets the output high for undriven open, short, or terminated inputs.

The MAX9180 operates from a single 3.3V supply and consumes only 10mA over a -40°C to +85°C temperature range. Refer to the MAX9129 data sheet for a quad bus LVDS (BLVDS) driver, and to the MAX9181 data sheet for a low-jitter, low-noise 400Mbps LVPECL-to-LVDS level translator in an SC70 package.

Applications

Cellular Phone Base Stations DSLAMs Digital Cross-Connects Add/Drop Muxes Network Switches/Routers Multidrop Buses Cable Repeaters

Typical Operating Circuit appears at end of data sheet.

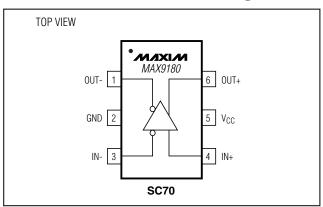
_Features

- Tiny SC70 Package
- Ultra-Low Jitter
 23psp-p Added Deterministic Jitter (2²³- 1 PRBS)
 0.6ps_{RMS} Added Random Jitter
- 0.5ns (min) Transition Time Minimizes Radiated Noise
- ♦ 400Mbps Guaranteed Data Rate
- Fail-Safe Circuit Sets Output High for Undriven Inputs (Open, Terminated, or Shorted)
- Low 10mA Supply Current
- Low 6mA Supply Current in Fail-Safe
- Conforms to ANSI/EIA/TIA-644 LVDS Standard
- High-Impedance Inputs and Outputs in Power-Down Mode

Ordering Information

| PART | TEMP RANGE | PIN- PACKAGE | top Mark |
|--------------|----------------|-----------------|-------------|
| MAX9180EXT-T | -40°C to +85°C | 6 SC70-6 | ABH |

Pin Configuration



Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

ABSOLUTE MAXIMUM RATINGS

| V _{CC} to GND | 0.3V to +4.0V |
|--|---------------|
| IN+, IN- to GND | 0.3V to +4.0V |
| OUT+, OUT- to GND | 0.3V to +4.0V |
| Short-Circuit Duration (OUT+, OUT-) | Continuous |
| Continuous Power Dissipation ($T_A = +70^\circ$ | C) |
| 6-Pin SC70 (derate 3.1mW/°C above + | 70°C)245mW |

| Storage Temperature Range | |
|--------------------------------------|---------------|
| Junction Temperature | +150°C |
| Operating Temperature Range | 40°C to +85°C |
| ESD Protection | |
| Human Body Model, IN+, IN-, OUT+, Ol | JT±8kV |
| Lead Temperature (soldering, 10s) | +300°C |

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

DC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 3.0V \text{ to } 3.6V, R_L = 100\Omega \pm 1\%, |V_{ID}| = 0.05V \text{ to } 1.2V, V_{CM} = |V_{ID} / 2| \text{ to } 2.4V - |V_{ID} / 2|, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ noted. Typical values are at V_{CC} = 3.3V, T_A = +25°C.) (Notes 1, 2)

| PARAMETER | SYMBOL | | CONDITIONS | MIN | ТҮР | МАХ | UNITS |
|--|-------------------------------------|---|--------------------------------|-------|-------|---------|-------|
| LVDS INPUT | | | | | | | |
| Differential Input High Threshold | V _{TH} | | | | 7 | 50 | mV |
| Differential Input Low Threshold | V _{TL} | | | -50 | -7 | | mV |
| Input Ourrent | lus lus | $0.05V \le V_{ID} \le 0.6V$ | | -15 | -2.5 | +15 | |
| Input Current | I _{IN+} , I _{IN-} | $0.6V < V_{ID} $ | ≤ 1.2V | -20 | -3.5 | 3.5 +20 | μA |
| Power-Off Input Current | lus lus | $0.05V \le V_{ID} \le 0.6V, V_{CC} = 0V$ | | -15 | +1.3 | +15 | |
| Fower-On input Current | I _{IN+} , I _{IN-} | $0.6V < V_{ D} $ | $ \le 1.2 V, V_{CC} = 0 V$ | -20 | +2.6 | +20 | μA |
| Input Resistor 1 | RIN1 | V _{CC} = 3.6V | / or 0V, Figure 1 | 67 | 232 | | kΩ |
| Input Resistor 2 | R _{IN2} | V _{CC} = 3.6V | / or 0V, Figure 1 | 267 | 1174 | | kΩ |
| LVDS OUTPUT | | | | | | | |
| Differential Output Voltage | VOD | Figure 2 | | 250 | 360 | 450 | mV |
| Change in V _{OD} Between Complementary Output States | ΔV_{OD} | Figure 2 | | | 0.008 | 25 | mV |
| Offset (Common-Mode) Voltage | Vos | Figure 2 | | 1.125 | 1.25 | 1.375 | V |
| Change in V _{OS} for Complementary Output States | ΔV_{OS} | Figure 2 | | | 0.005 | 25 | mV |
| Output High Voltage | Voн | | | | 1.44 | 1.6 | V |
| Output Low Voltage | Vol | | | 0.9 | 1.08 | | V |
| Fail-Safe Differential Output Voltage | V _{OD+} | IN+, IN- shorted, open, or parallel terminated | | +250 | +360 | +450 | mV |
| Power-Off Output Leakage | 10 | | OUT+ = 3.6V, other output open | -10 | +0.02 | +10 | |
| Current | IOOFF | VCC = 0V | OUT- = 3.6V, other output open | -10 | +0.02 | +10 | μA |
| Differential Output Resistance | RODIFF | V _{CC} = 3.6V or 0V | | 100 | 260 | 400 | Ω |
| | | $V_{ID} = 50$ mV, OUT+ = GND $V_{ID} = -50$ mV, OUT- = GND | | | -5 | -15 | |
| Output Short Current | ISC | | | | -5 | -15 | mA |
| POWER SUPPLY | | - | | • | | | • |
| Supply Current | Icc | Output loaded | | | 10 | 15 | mA |
| Supply Current in Fail-Safe | ICCF | Output loaded, input undriven | | | 6 | 8 | mA |

M/X/M

AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 3.0V \text{ to } 3.6V, R_L = 100\Omega \pm 1\%, C_L = 10pF, |V_{ID}| = 0.15V \text{ to } 1.2V, V_{CM} = |V_{ID} / 2| \text{ to } 2.4V - |V_{ID} / 2|, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.}$ otherwise noted. Typical values are at V_{CC} = 3.3V, T_A = +25^{\circ}C.) (Notes 3, 4, 5) (Figures 3, 4)

| PARAMETER | SYMBOL | CONDITIONS | MIN | ТҮР | МАХ | UNITS |
|---|-------------------|--|-----|------|-----|-------------------|
| Differential Propagation Delay High to Low | ^t PHLD | | 1.3 | 2.0 | 2.8 | ns |
| Differential Propagation Delay Low to High | ^t PLHD | | 1.3 | 2.0 | 2.8 | ns |
| Added Deterministic Jitter | t _{DJ} | 400Mbps 2 ²³ - 1 PRBS data pattern (Notes 6, 11) | | 23 | 100 | psp-p |
| Added Random Jitter | t _{RJ} | f _{IN} = 200MHz (Notes 7, 11) | | 0.6 | 2.9 | ps _{RMS} |
| Differential Part-to-Part Skew | tSKPP1 | (Note 8) | | 0.16 | 0.6 | ns |
| | tSKPP2 | (Note 9) | | | 1.5 | ns |
| Switching Supply Current | Iccsw | | | 12.2 | 18 | mA |
| Rise Time | t _{TLH} | | 0.5 | 0.67 | 1.0 | ns |
| Fall Time | t _{THL} | | 0.5 | 0.66 | 1.0 | ns |
| Input Frequency | fMAX | (Note 10) | 200 | | | MHz |

Note 1: All devices are 100% tested at $T_A = +25^{\circ}$ C. Limits over temperature are guaranteed by design and characterization.

Note 2: Current into a pin is defined as positive. Current out of a pin is defined as negative. All voltages are referenced to ground except V_{TH} , V_{TL} , V_{OD} , and ΔV_{OD} .

Note 3: Guaranteed by design and characterization.

Note 4: Signal generator output (unless otherwise noted): frequency = 200MHz, 50% duty cycle, $R_0 = 50\Omega$, $t_R = 1.5ns$, and $t_F = 1.5ns$ (0% to 100%).

Note 5: C_L includes scope probe and test jig capacitance.

Note 6: Signal generator output for t_{DJ}: V_{OD} = 150mV, V_{OS} = 1.2V, t_{DJ} includes pulse (duty-cycle) skew.

Note 7: Signal generator output for t_{RJ} : $V_{OD} = 150 \text{mV}$, $V_{OS} = 1.2 \text{V}$.

Note 8: t_{SKPP1} is the magnitude difference of any differential propagation delays between devices operating over rated conditions at the same supply voltage, input common-mode voltage, and ambient temperature.

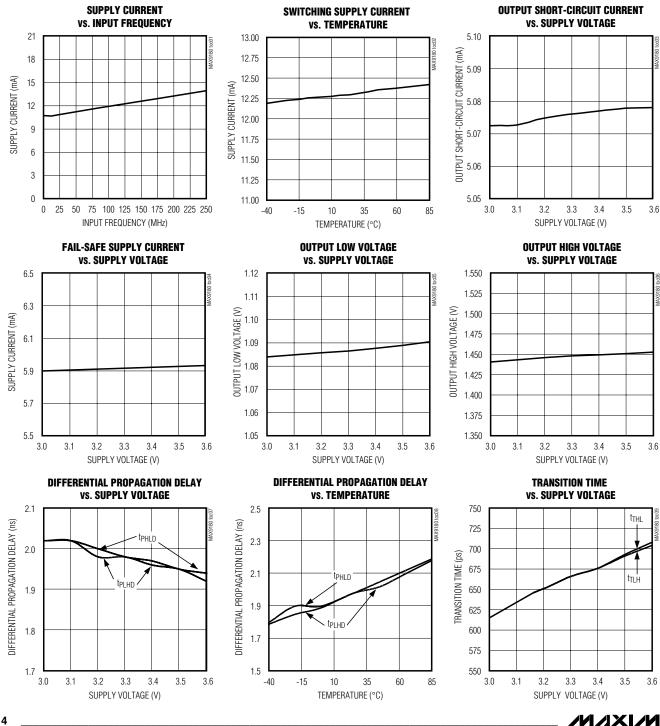
Note 9: t_{SKPP2} is the magnitude difference of any differential propagation delays between devices operating over rated conditions. **Note 10:** Device meets V_{OD} DC specification and AC specifications while operating at f_{MAX}.

Note 11: Jitter added to the input signal.

M/IXI/M

Typical Operating Characteristics

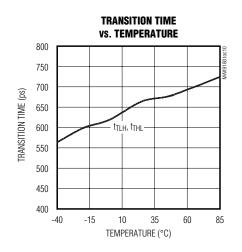
 $(V_{CC} = 3.3V, R_L = 100\Omega \pm 1\%, C_L = 10pF, |V_{ID}| = 0.2V, V_{CM} = 1.2V, T_A = +25^{\circ}C$, unless otherwise noted. Signal generator output: frequency = 200MHz, 50% duty cycle, $R_0 = 50\Omega$, $t_R = 1.5ns$, and $t_F = 1.5ns$ (0% to 100%), unless otherwise noted.)

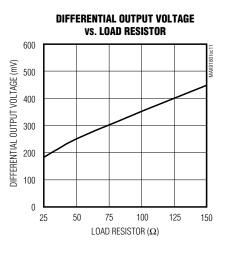


4

_Typical Operating Characteristics (continued)

 $(V_{CC} = 3.3V, R_L = 100\Omega \pm 1\%, C_L = 10pF, |V_{ID}| = 0.2V, V_{CM} = 1.2V, T_A = +25^{\circ}C$, unless otherwise noted. Signal generator output: frequency = 200MHz, 50% duty cycle, $R_O = 50\Omega$, $t_R = 1.5ns$, and $t_F = 1.5ns$ (0% to 100%), unless otherwise noted.)





Pin Description

| PIN | NAME | FUNCTION | |
|-----|-----------------|---|--|
| 1 | OUT- | Inverting LVDS Output | |
| 2 | GND | Ground | |
| 3 | IN- | Inverting LVDS Input | |
| 4 | IN+ | Noninverting LVDS Input | |
| 5 | V _{CC} | Power Supply. Bypass V_{CC} to GND with a 0.01µF ceramic capacitor. | |
| 6 | OUT+ | Noninverting LVDS Output | |

Table 1. Function Table for LVDS Fail-Safe Input (Figure 2)

| INPUT, V _{ID} | OUTPUT, V _{OD} |
|-------------------------------------|-------------------------|
| <u>></u> 50mV | High |
| <u><</u> -50mV | Low |
| $50mV > V_{ID} > -50mV$ | Indeterminate |
| Undriven open, short, or terminated | High |

Note: $V_{ID} = (IN+ - IN-), V_{OD} = (OUT+ - OUT-)$ High = 450mV ≥ $V_{OD} ≥ 250mV$ Low = -250mV ≥ $V_{OD} ≥ -450mV$

Detailed Description

The LVDS interface standard is a signaling method intended for point-to-point communication over a controlled-impedance medium, as defined by the ANSI/ TIA/EIA-644 and IEEE 1596.3 standards. The LVDS standard uses a lower voltage swing than other common communication standards, achieving higher data rates with reduced power consumption while reducing EMI emissions and system susceptibility to noise.

The MAX9180 is a 400Mbps LVDS repeater intended for high-speed, point-to-point, low-power applications. The MAX9180 accepts an LVDS input and reproduces an LVDS signal at the output. This device is capable of detecting differential signals as low as 50mV and as high as 1.2V within a 0 to 2.4V input voltage range. The LVDS standard specifies an input voltage range of 0 to 2.4V referenced to ground.

Fail-Safe

Fail-safe is a feature that puts the output in a known logic state (differential high) under certain fault conditions. The MAX9180 outputs are differential high when the inputs are undriven and open, terminated, or shorted (Table 1).

MAX9180



Applications Information

Supply Bypassing

Bypass V_{CC} with a high-frequency surface-mount ceramic 0.01µF capacitor as close to the device as possible.

Differential Traces

Input and output trace characteristics affect the performance of the MAX9180. Use controlled-impedance differential traces. Ensure that noise couples as common mode by running the traces within a differential pair close together.

Maintain the distance within a differential pair to avoid discontinuities in differential impedance. Avoid 90° turns and minimize the number of vias to further prevent impedance discontinuities.

Cables and Connectors

The LVDS standards define signal levels for interconnect with a differential characteristic impedance and termination of 100Ω . Interconnects with a characteristic impedance and termination of 90Ω to 132Ω impedance are allowed, but produce different signal levels (see the *Termination* section).

Use cables and connectors that have matched differential impedance to minimize impedance discontinuities.

Avoid the use of unbalanced cables, such as ribbon or coaxial cable. Balanced cables, such as twisted pair, offer superior signal quality and tend to generate less EMI due to canceling effects. Balanced cables tend to pick up noise as common mode, which is rejected by the LVDS receiver.

Termination

For point-to-point links, the termination resistor should be located at the LVDS receiver input and match the

differential characteristic impedance of the transmission line.

For a multidrop bus driven at one end, terminate at the other end of the bus with a resistor that matches the loaded differential characteristic impedance of the bus. For a multidrop bus driven from a point other than the end, terminate each end of the bus with a resistor that matches the loaded differential characteristic impedance of the bus. When terminating at both ends, or for a large number of drops, a BLVDS driver is needed to drive the bus to LVDS signal levels. The MAX9180 is not intended to drive double-terminated multidrop buses to LVDS levels.

The differential output voltage level depends upon the differential characteristic impedance of the interconnect and the value of the termination resistance. The MAX9180 is guaranteed to produce LVDS output levels into 100 Ω . With the typical 3.6mA output current, the MAX9180 produces an output voltage of 360mV when driving a 100 Ω transmission line terminated with a 100 Ω termination resistor (3.6mA x 100 Ω = 360mV). For typical output levels with different loads, see the Differential Output Voltage vs. Load Resistor curve in the *Typical Operating Characteristics*.

Chip Information

TRANSISTOR COUNT: 401 PROCESS: CMOS

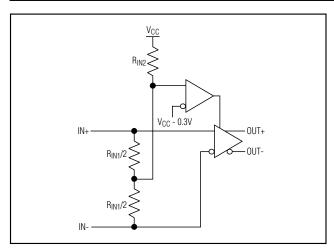


Figure 1. LVDS Fail-Safe Input

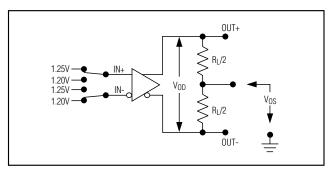


Figure 2. DC Load Test Circuit

Test Circuit and Timing Diagrams

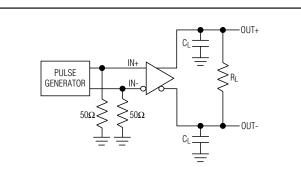


Figure 3. Transition Time and Propagation Delay Test Circuit

MAX9180

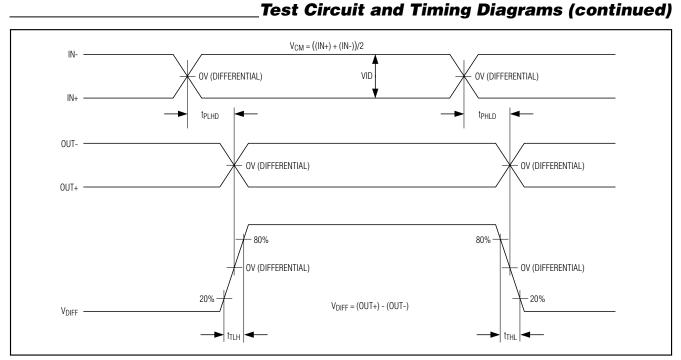
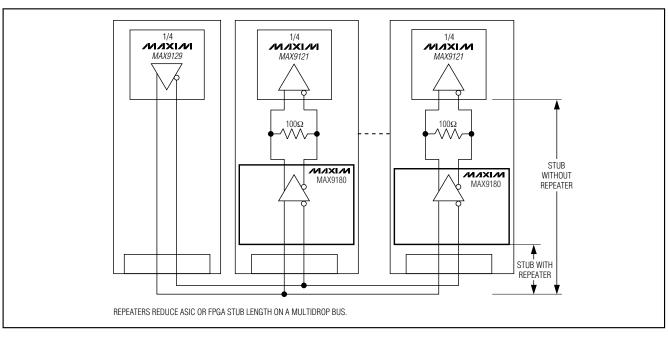


Figure 4. Transition Time and Propagation Delay Timing Diagram

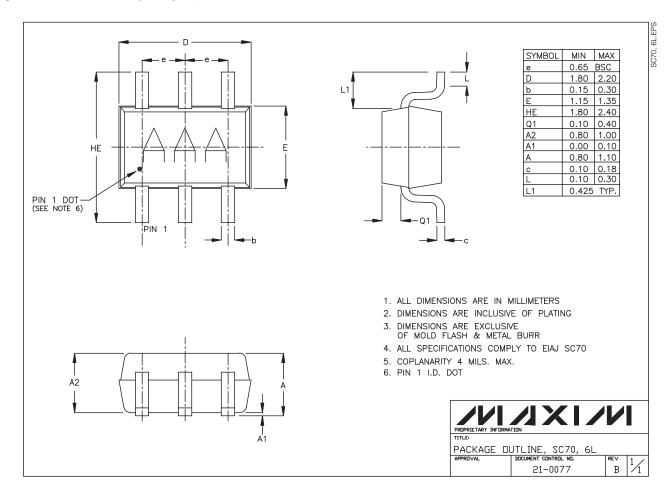


Typical Operating Circuit



Package Information

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to **www.maxim-ic.com/packages**.)



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